

N-Channel Enhancement Mode Power MOSFET

Description

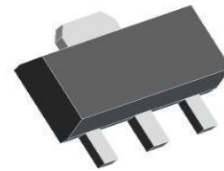
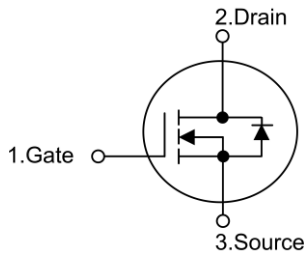
The XXW20N03Q uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

Application

- PWM applications
- Load switch
- Power management

General Features

- $V_{DS} = 30V, I_D = 20A$
 - $R_{DS(ON)} < 35m$ @ $V_{GS}=5V$
 - $R_{DS(ON)} < 25m$ @ $V_{GS}=10V$
- High density cell design for ultra low $R_{DS(on)}$
- Excellent package for good heat dissipation



SOT-89

Maximum Ratings ($T_c = 25^\circ C$ unless otherwise noted*)

Parameter	Symbol	Ratings	Units
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current	ID	$T_c=25^\circ C$	2*
		$T_c=100^\circ C$	4*
Pulsed Drain Current	I_{DM}	3	A
Power Dissipation	PD	$T_c=25^\circ C$	27
		Derate above $25^\circ C$	0.216
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+175	$^\circ C$

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Parameter	Symbol	Ratings	Units
Thermal resistance junction to ambient.	R_{thJA}	105	$^\circ C/W$

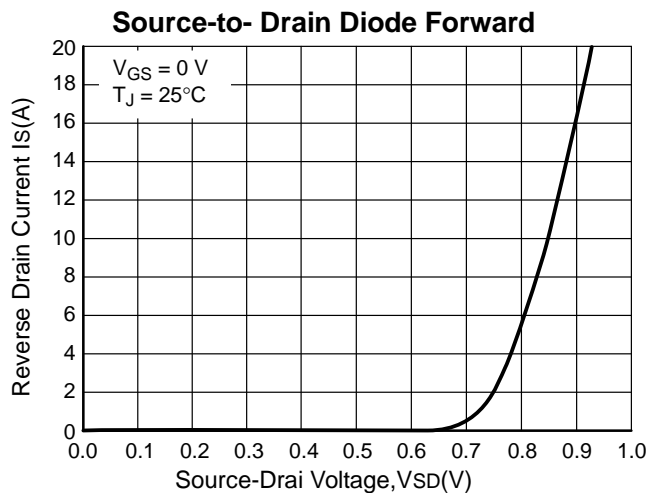
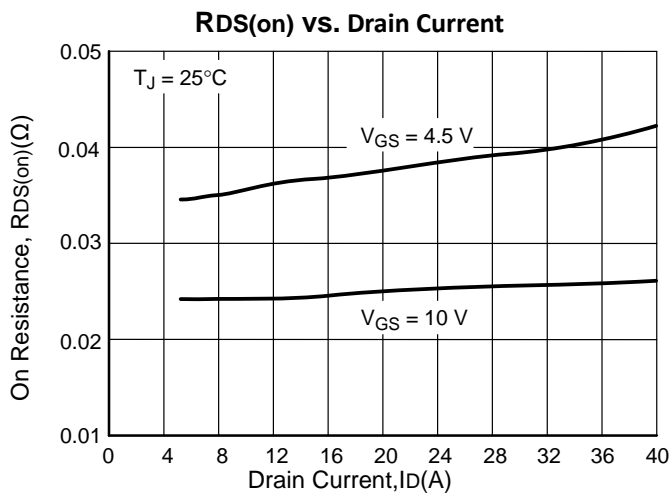
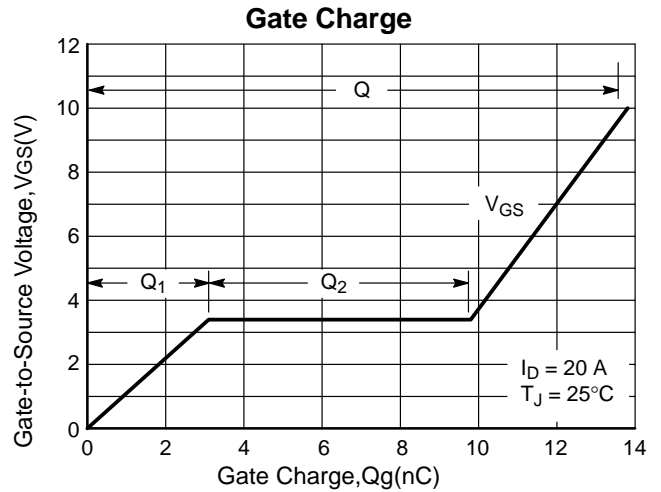
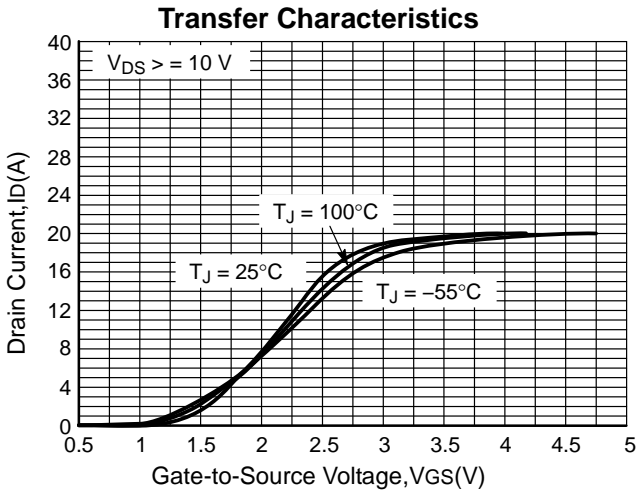
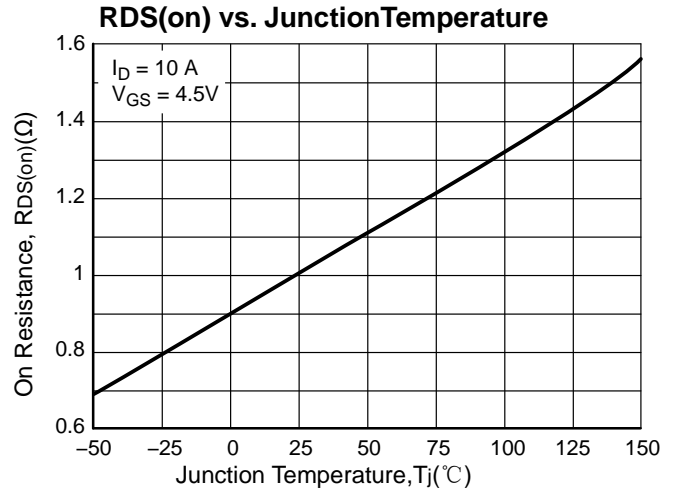
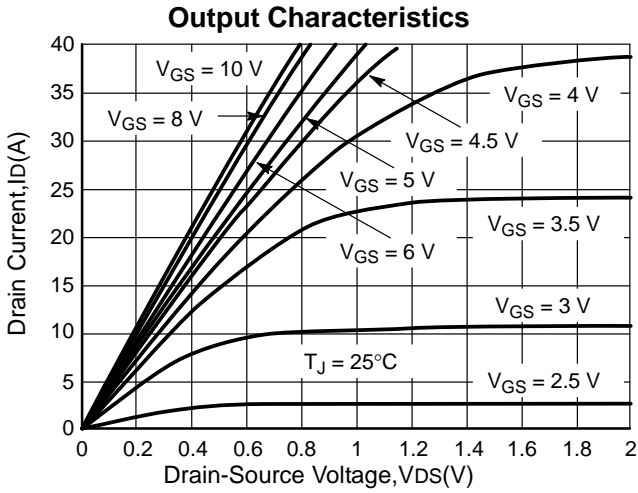
Electrical characteristics (TA =25°C Unless Otherwise Specified)

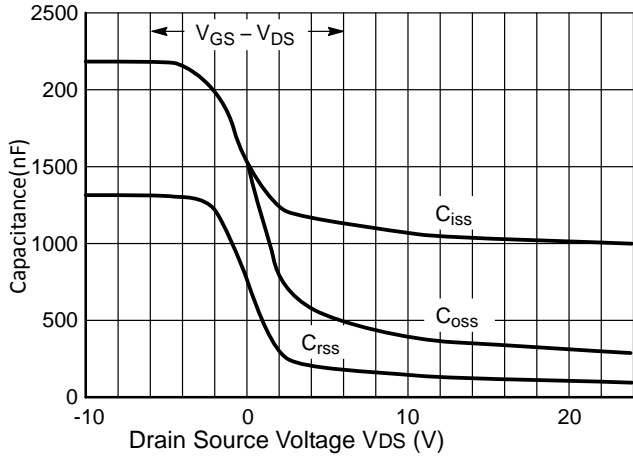
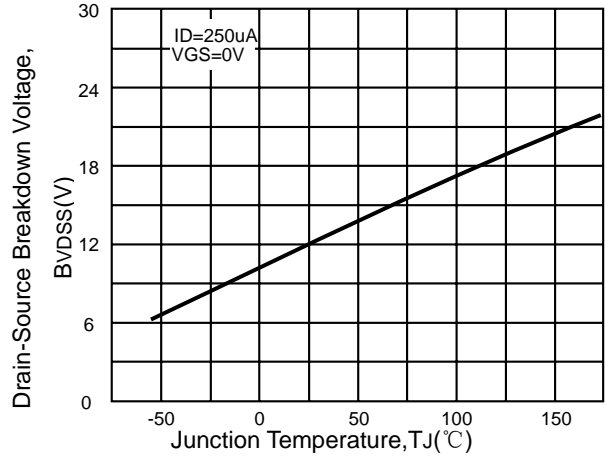
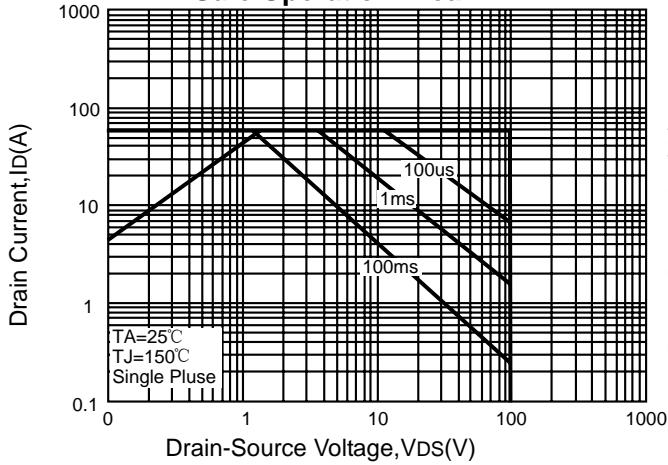
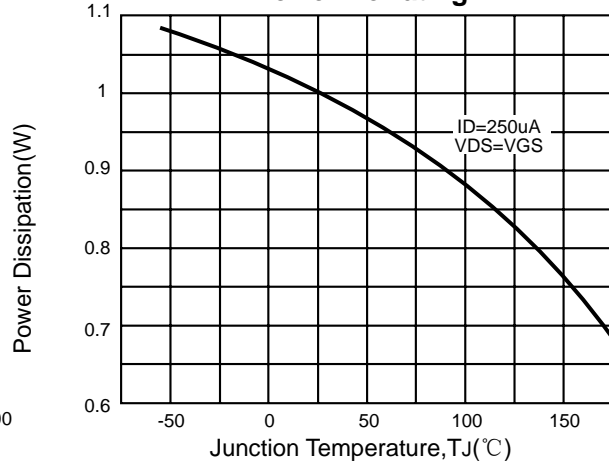
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
STATIC						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V, ID=250μA	30	—	—	V
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=250μA	1	—	3	V
IGSS	Gate-Body Leakage	VDS=0V, VGS=±20V	—	—	±100	nA
IDSS	Zero Gate Voltage Drain Current	VDS=24V, VGS=0V	—	—	1	μA
RDS(ON)	Drain-Source On-Resistance	VGS=10V, ID=10A	—	—	25	mΩ
		VGS=4.5V, ID=8A	—	—	35	mΩ
VSD	Diode Forward Voltage	IS=3A, VGS=0V	—	—	1.3	V
DYNAMIC						
Qg	Total Gate Charge	VDS=15V, VGS=10V, ID=10A	—	12	—	nC
Qgs	Gate-Source Charge		—	5.5	—	
Qgd	Gate-Drain Charge		—	2.2	—	
Ciss	Input Capacitance	VDS=15V, VGS=0V, f=1MHz	—	660	—	pF
Coss	Output Capacitance		—	143	—	
Crss	Reverse Transfer Capacitance		—	77	—	
td(on)	Turn-On Delay Time	VDD =15V, RG=3Ω RL=2Ω, VGS=5V,	—	5	—	ns
tr	Turn-On Rise Time		—	3.2	—	
td(off)	Turn-Off Delay Time		—	24	—	
tf	Turn-Off Fall Time		—	6	—	
ISD	Continuous drain-source current		—	—	2	A
ISM	Pulsed drain-source current		—	—	4	A

Notes :a. Pulse test:pulse width 300 us,duty cycle 2% ,Guaranteed by design,not subject to production testing.

b. HN reserves the right to improve product design,functions and reliability without notice.

Typical Characteristics (T_J = 25°C Noted)



Capacitance vs. Drain Source Voltage

 BV_{DSS} vs. Junction Temperature

Safe Operation Area

Power De-rating

Normalized Thermal Transient Impedance, Junction to Ambient
